EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1113	ARITA-KIYOSHI.in. IWAI-TETSUHIRO.in. NAKAGAWA-AKIRA.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 12:05
S2	1	S1 and (blocking with ring) and (cover with ceramic)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 12:22
S3	1	S1 and (blocking with ring)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 12:20
S4	0	"matsushita-electric.as"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 12:21
S5	559065	matsushita adj electric.as.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 12:22
S6	1	S5 and (blocking with ring) and (cover with ceramic)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 12:23
S7	30	S5 and (blocking with ring)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 12:32

S8	4	("20030037882"|"6583979").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 13:16
S9	6	"2001033369".pn. "2002140148".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 13:17
S10	3	"2001077184".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 13:21
S11	0	"2001033369".pn. "2005018169".pn. "2002140148".pn.	US-PGPUB	OR	ON	2007/07/27 13:22
S12	1	"2001326270".pn.	JPO	OR	ON	2007/07/27 13:30
S13	0	"2002140148 A1"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 13:31
S14	12	"1215716"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 13:32
S15	1	"EP 1215716"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 13:34

S16	2	"20020140148".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/27 13:34
S17	10	("4480284" | "4520421" | "5055964" | "5099571" | "5191506" | "5345999" | "5572398" | "5625526" | "5886863" | "5909354").PN. OR ("6583979"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/27 17:41
S18	32	("4384918" | "5055964" | "5099571").PN. OR ("5572398"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/27 18:19
S19	48565	(118/715.ccls. or 118/724.ccls. or 118/725.ccls. or 118/728.ccls. or 118/50.ccls. or 118/723e.ccls. or 118/723er.ccls. or 156/345.26.ccls. or 156/345.29.ccls. or 156/345.33. ccls. or 156/345.34.ccls. or 156/345.35.ccls. or 156/345.36.ccls. or 156/345.43-345.47.ccls or 156/345.51.ccls.) or (137/262-264. ccls. or 137/454.2 or 137/560.ccls. or 137/561r.ccls. or 137/561a.ccls. or 137/571-576.ccls. or 137/590. ccls. or 137/594-596.ccls. or 137/599.01.ccls. or 137/599. 05-599.07.ccls. or 137/602.ccls.) or (141/285-286.ccls. or 141/37.ccls. or 141/44-47.ccls. or 141/54.ccls. or 141/301-302.ccls. or 141/367.ccls.) or (261/127.ccls. or 261/131.ccls. or 261/146-147.ccls. or 261/150.ccls.) or (261/19-22.ccls. or 261/23.1.ccls. or 261/40.ccls. or 261/42.ccls. or 261/62-63.ccls.) or (261/64.1.ccls. or 261/65.ccls. or 261/75-76.ccls. or 261/94-96.ccls. or 261/100-102. ccls. or 261/105.ccls. or 261/108-109.ccls. or 261/113.ccls. or 261/114.1.ccls.) 156/345.52,345. 53.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 16:57
S20	1584	S19 and ((susceptor support chuck pedestal platen stage holder platform mounting) with (cover or "insulating film"))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/28 15:23

S21	20725	S19 and (@rlad<="20030723" or @ad<="20030723")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/02 18:22
S22	1175	S21 and ((susceptor support chuck pedestal platen stage holder platform mounting) with (cover or "insulating film"))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/28 18:21
S23	52	S22 and (cover with detach$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/28 16:16
S24	87	S22 and (cover with protect)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/28 16:16
S25	84	S24 not S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/28 16:16
S26	19	("3179213" | "4078812" | "4167351" | "4668373" | "5066381" | "5074456" | "5161908" | "5178681" | "5238499" | "5257872" | "5269894" | "5494523").PN. OR ("5589003").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/28 18:04
S27	223	S21 and (shield$2 with (substrate or wafer) with (support or holder))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/29 16:10

S28	160	(plasma and (chamber with (substrate or wafer))) and ((small$2 adj (substrate or wafer)) same (larg$2 adj (substrate or wafer)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 11:00
S29	263	((chamber with (substrate or wafer))) and ((small$2 adj (substrate or wafer)) same (larg$2 adj (substrate or wafer)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/29 17:26
S30	103	S29 not S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/29 17:41
S31	1	S30 and ((accommodat$3 or adapt$3) near3 (small and large))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/29 17:29
S32	16	("3467242" | "4261464" | "4308953" | "4446966" | "4574950" | "4602715" | "5653565" | "5706946" | "5711427" | "5755332").PN. OR ("6095335"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/29 17:35
S33	102	S30 not (S31 S32)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/29 17:41
S34	13	("4261762" | "4457359" | "4512391" | "4542298" | "4680061" | "4705951" | "4743570" | "4909314" | "4949783" | "5001423" | "5583737").PN. OR ("6183523"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/29 18:14

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S35	2	"6822730".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/29 18:16
S36	6	("20030211813" | "5441911" | "5820329" | "6164633" | "6258228").PN. OR ("6822730"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/29 18:16
S37	14	("4131267" | "4448404" | "5191218" | "5324012" | "5564682" | "6032997").PN. OR ("6164633"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/29 18:18
S38	4	(plasma and (chamber with (substrate or wafer))) and ((susceptor support chuck mount$3 holder stage platform pesdestal platen) with ((inner and outer) adj area))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 11:10
S39	1	(plasma and (chamber with (substrate or wafer))) and ((substrate adj support) with ((inner and outer) adj area))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 11:13
S40	1	((chamber with (substrate or wafer))) and ((substrate adj support) with ((inner and outer) adj area))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 11:13
S41	10	((chamber with (substrate or wafer))) and ((substrate adj support) with (insulating adj film))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 11:19
S42	316	((chamber with (substrate or wafer))) and ((support susceptor pedestal mounting chuck) with (insulating adj film))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 11:34

S43	646	((chamber with (substrate or wafer))) and ((support susceptor pedestal mounting chuck) with (divided))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 14:57
S44	17	((chamber with (substrate or wafer))) and ((support susceptor pedestal mounting chuck) with (divided adj (area section portion)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 11:21
S45	129	S42 and (insulat$3 with (ring separat$3 concentric area divide))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 11:36
S46	1100	((chamber with (substrate or wafer))) and ((support susceptor pedestal mounting chuck) with (suction))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 14:58
S47	524	((chamber with (substrate or wafer))) and ((support susceptor pedestal mounting chuck) near3 (suction))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 14:58
S48	331	S47 and (suction near3 (wafer substrate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 15:20
S49	20	("20020021959"|"20030038112"|"20030053075"|"20030056899"|"5589928"|"5796486"|"6077387"|"6164633"|"6511895"|"6592673").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 15:20

S50	2881	118/728.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 16:45
S51	329	S50 and ((small and large) with (substrate wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 16:48
S52	319	S51 not (S38 S39 S40 S41 S42 S44 S45 S48 S49)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 16:47
S53	569	S50 and ((small$2 and large$2) with (substrate wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 16:48
S54	54	S50 and ((small$2 and large$2) adj (substrate wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 17:48
S55	33	(quantum adj dot) and substrate and atomizer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 18:03
S56	2	"4692836".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 19:10

S57	54	("4384918" | "4520421").PN. OR ("4692836").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/31 22:58
S58	144	("3634740" | "3916270" | "4184188" | "4282267" | "4292153" | "4313783" | "4324611").PN. OR ("4384918").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/31 12:49
S59	784	361/234.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/31 13:01
S60	607	S59 and (@rlad<="20030723" or @ad<="20030723")	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/31 13:02
S61	13	S60 and (plasma and suction)	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/31 13:02
S62	5	("6556414").URPN.	USPAT	OR	ON	2007/07/31 13:15
S63	54	("4384918" | "4520421").PN. OR ("4692836").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/31 22:59
S64	9	S63 and (insulat$3 near3 ceramic)	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 11:21
S65	14	("electrostatic adj chuck" "esc") and (vacuum same (suction near3 hole))	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 11:30
S66	4023	(chuck susceptor holder support) same ((vacuum or suction) near3 hole)	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 11:32
S67	424	(chuck susceptor holder support) with (substrate or wafer) with ((vacuum or suction) adj hole)	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 11:46
S68	125	S67 and plasma	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 15:19
S69	15	S67 and (cover$3 near3 holes)	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 14:49
S70	784	361/234.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 16:08
S71	12	S66 and S70	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 14:50
S72	123	S68 not (S69 S71)	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 15:20

S73	15	S70 and ("dummy wafer")	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 16:08
S74	20	("4384918" | "5055964" | "5151845" | "5548470" | "5572398" | "5612850" | "5671119" | "5675471" | "5677824" | "5699223" | "5781400" | "5793192" | "5798904" | "5946184").PN. OR ("6243251").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 16:54
S75	0	("dummy wafer" with cover with hole) and (plasma with chamber with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 16:58
S76	1	("dummy wafer" with cover with hole) and (chamber with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 16:58
S77	0	("2006/0175772").URPN.	USPAT	OR	ON	2007/08/01 17:34
S78	0	(plasma same (chamber with (substrate or wafer))) and (((vacuum or suction) adj holes) with cover)	USPAT	OR	ON	2007/08/01 17:55
S79	6	((chamber with (substrate or wafer))) and (((vacuum or suction) adj holes) with cover)	USPAT	OR	ON	2007/08/01 17:55
S80	2	"6815646".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 20:31
S81	14	("4131267" | "4448404" | "5191218" | "5324012" | "5564682" | "6032997").PN. OR ("6164633"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 20:53
S82	11	("4158171" | "4796562" | "4846452" | "4849916" | "5923408" | "6032997" | "6073681" | "6164633" | "6196532" | "6257564").PN. OR ("6538733"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 20:55

S83	2882	118/728.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/02 18:21
S84	2632	S83 and (@rlad<="20030723" or @ad<="20030723")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/02 18:22
S85	928	S84 and (ring)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/02 18:23
S86	238	S85 and (ring with (cover$3 or protect$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/03 12:55
S87	2882	118/728.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/03 12:55
S88	2632	S87 and (@rlad<="20030723" or @ad<="20030723")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/03 12:55
S89	928	S88 and (ring)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/03 12:55

S90	5	S89 and (ring near3 resin)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/03 12:55
S91	6	(US-5625526-$ or US-5589003-$ or US-6164633-$ or US-6815646-$ or US-5670066-$ or US-5463526-$).did.	USPAT	OR	ON.	2007/08/03 13:00
S92	2	S91 and resin	USPAT	OR	ON	2007/08/03 13:11
S93	858	156/345.14,345.23,345.51.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/03 15:24
S94	102	S93 and (ring near3 (cover$3 or protect$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/03 15:26
S95	13	S93 and (ring near3 material near2 (substrate wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/03 15:26